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Revision History

Rev	ECN #	Approved Date	Approved by	Notes
N/A	N/A	N/A	N/A	N/A

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B

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TID #: <a href="#">N/A</a>	Project Title: <a href="#">RF430-TMPSNS-EVM</a>		
Number: <a href="#">RF430-TMPSNS-EVM</a>	Sheet Title:		
SVN Rev: <a href="#">Version control disabled</a>	Assembly Variant: <a href="#">001</a>	Sheet: <a href="#">1</a> of <a href="#">3</a>	
Drawn By:	File: <a href="#">RF430_TMPSNS_EVM_A_CoverSheet.SchDoc</a> Size: B		
Engineer: <a href="#">Eddie LaCost</a>	Contact: <a href="http://www.ti.com/support">http://www.ti.com/support</a>		

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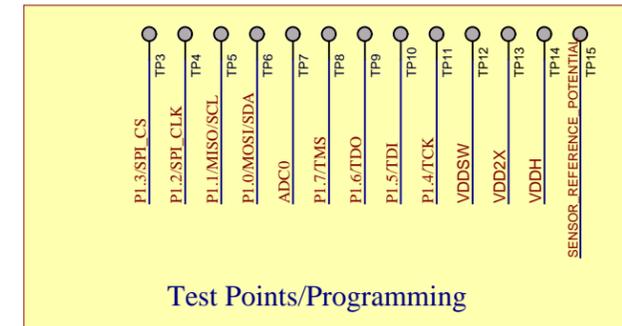
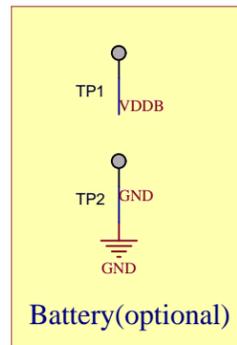
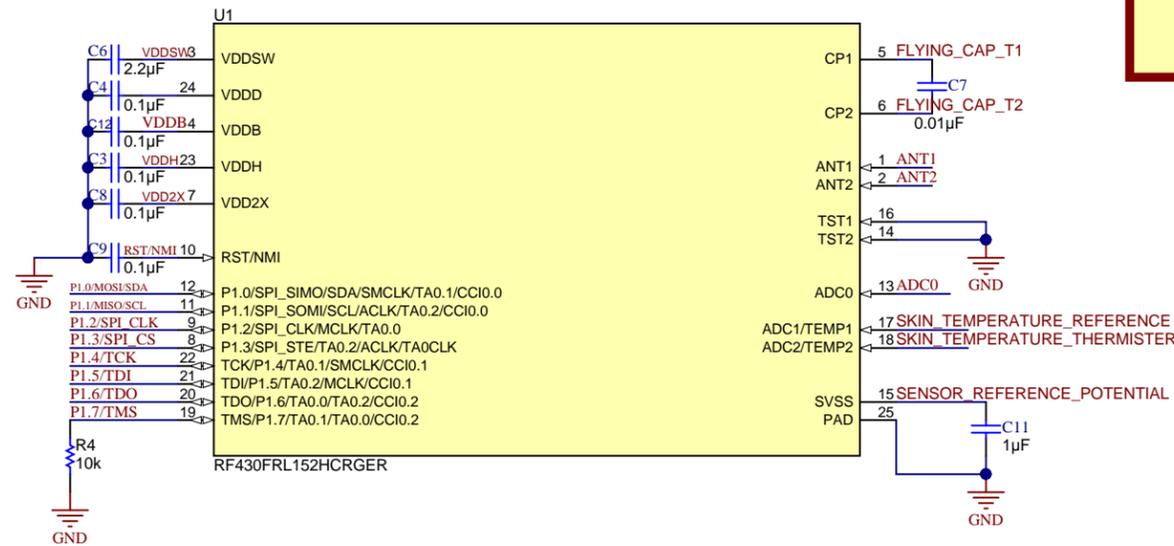
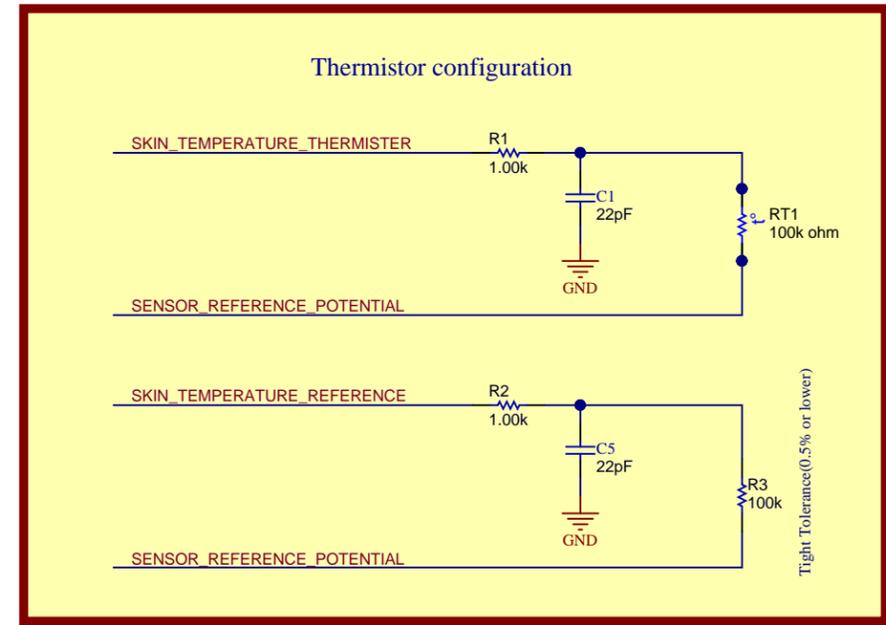
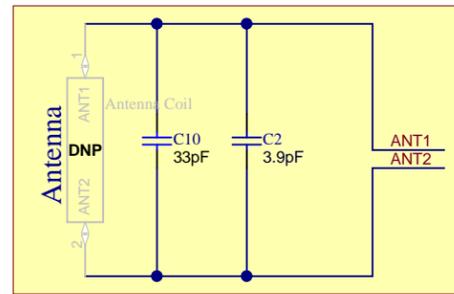
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Number: <b>RF430-TMPSNS-EVM</b>	Sheet Title:	
SVN Rev: Version control disabled	Assembly Variant: <b>001</b>	Sheet: <b>2</b> of <b>3</b>
Drawn By:	File: <b>RF430_TMPSNS_EVM_A_SchDoc</b>	Size: <b>B</b>
Engineer: <b>Eddie LaCost</b>	Contact: <a href="http://www.ti.com/support">http://www.ti.com/support</a>	



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PCB Number: RF430-TMPSNS-EVM  
PCB Rev: A

PCB  
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Pb-Free Symbol

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FCC disclaimer

ZZ1  
Label Assembly Note  
This Assembly Note is for PCB labels only

ZZ2  
Assembly Note  
These assemblies are ESD sensitive, ESD precautions shall be observed.

ZZ3  
Assembly Note  
These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.

ZZ4  
Assembly Note  
These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.

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Number: <a href="#">RF430-TMPSNS-EVM</a>	Sheet Title:		
SVN Rev: <a href="#">Version control disabled</a>	Assembly Variant: <a href="#">001</a>	Sheet: <a href="#">3</a> of <a href="#">3</a>	
Drawn By:	File: <a href="#">RF430_TMPSNS_EVM_A_Hardware.SchDoc</a>	Size: B	
Engineer: <a href="#">Eddie LaCost</a>	Contact: <a href="http://www.ti.com/support">http://www.ti.com/support</a>		

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